### INTEGRATED CIRCUITS

# DATA SHEET

# 74ALVCH16843

18-bit bus-interface D-type latch (3-State)

**Product specification** 

1998 Aug 04

IC24 Data Handbook





### 18-bit bus interface D-type latch (3-State)

### 74ALVCH16843

#### **FEATURES**

- Wide supply voltage range of 1.2V to 3.6V
- Complies with JEDEC standard no. 8-1A.
- CMOS low power consumption
- Direct interface with TTL levels
- Current drive ± 24 mA at 3.0 V
- MULTIBYTE<sup>TM</sup> flow-through standard pin-out architecture
- Low inductance multiple V<sub>CC</sub> and GND pins for minimum noise and ground bounce
- All data inputs have bus hold
- Output drive capability 50Ω transmission lines @ 85°C

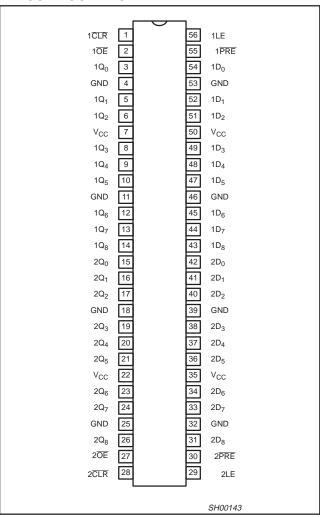
#### **DESCRIPTION**

The 74ALVCH16843 has two 9-bit D-type latch featuring separate D-type inputs for each latch and 3-State outputs for bus oriented applications. The two sections of each register are controlled independently by the latch enable (nLE), clear (nCLR), preset (nPRE) and output enable (nOE) control gates.

When  $n\overline{OE}$  is LOW, the data in the registers appear at the outputs. When  $n\overline{OE}$  is HIGH, the outputs are in the high impedance OFF state. Operation of the  $n\overline{OE}$  input does not affect the state of the flip-flops.

The 74ALVCH16843 has active bus hold circuitry which is provided to hold unused or floating data inputs at a valid logic level. This feature eliminates the need for external pull-up or pull-down resistors.

#### PIN CONFIGURATION



#### QUICK REFERENCE DATA

GND = 0V;  $T_{amb} = 25^{\circ}C$ ;  $t_r = t_f \le 2.5$ ns

SYMBOL	PARAMETER	CONDITION	NS	TYPICAL	UNIT
t <sub>PHL</sub> /t <sub>PLH</sub>	Propagation delay nDn to nQn	$V_{CC} = 2.5V, C_L = 30pF$ $V_{CC} = 3.3V, C_L = 50pF$	2.2 2.1	ns	
PHL/PLH	Propagation delay nLE to nQn	V <sub>CC</sub> = 2.5V, C <sub>L</sub> = 30pF V <sub>CC</sub> = 3.3V, C <sub>L</sub> = 50pF	2.3 2.0	ns	
C <sub>I</sub>	Input capacitance			5.0	pF
C <sub>PD</sub>	Power dissipation capacitance per buffer	$V_1 = GND \text{ to } V_{CC}^1$	transparent mode Output enabled Output disabled	17 3	pF
YPD YPD	Tower dissipation capacitance per buller	1 - 0.45 to AGC	Clocked mode Output enabled Output disabled	19 9	ρi

#### NOTES:

1.  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu W$ ):

 $\begin{aligned} &P_D = C_{PD} \times V_{CC}{}^2 \times f_i + \Sigma \ (C_L \times V_{CC}{}^2 \times f_o) \end{aligned} \ \text{where: } f_i = \text{input frequency in MHz; } C_L = \text{output load capacitance in pF; } f_o = \text{output frequency in MHz; } V_{CC} = \text{supply voltage in V; } \Sigma \ (C_L \times V_{CC}{}^2 \times f_o) = \text{sum of outputs.} \end{aligned}$ 

#### ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	DRAWING NUMBER
56-Pin Plastic Thin Shrink Small Outline (TSSOP) Type II	-40°C to +85°C	74ALVCH16843 DGG	ACH16843 DGG	SOT364-1

# 18-bit bus interface D-type latch (3-State)

### 74ALVCH16843

### **PIN DESCRIPTION**

PIN NUMBER	SYMBOL	NAME AND FUNCTION
1	1CLR	Clear input (active LOW)
2	1 <del>OE</del>	Output enable input (active LOW)
55	1PRE	Preset input (active LOW)
56	1LE	Latch enable input (active HIGH)
54, 52, 51, 49, 48, 47, 45, 44, 43	1D0 to 1D8	Data inputs
3, 5, 6, 8, 9, 10, 12, 13, 14	1Q0 to 1Q8	Data outputs
4, 11, 18, 25, 32, 39, 46, 53	GND	Ground (0V)
7, 22, 35, 50	$V_{CC}$	Positive supply voltage
27	2 <del>OE</del>	Output enable input (active LOW)
28	2 <del>CLR</del>	Clear input (active LOW)
29	2LE	Latch enable input (active HIGH)
30	2PRE	Preset input (active LOW)
42, 41, 40, 38, 37, 36, 34, 33, 31	2D0 to 2D8	Data inputs
15, 16, 17, 19, 20, 21, 23, 24, 26	2Q0 to 2Q8	Data outputs

### **FUNCTION TABLE**

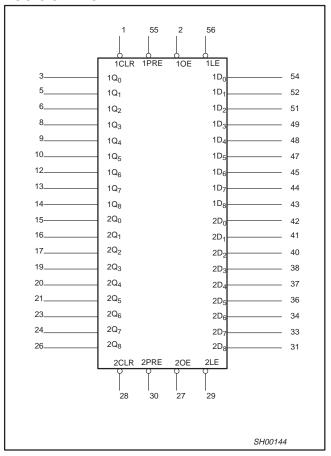
	INPUTS									
nPRE	nCLR	nOE	LE	D <sub>X</sub>	Q					
L	Х	L	Х	Х	Н					
Н	L	L	Х	Х	L					
Н	Н	L	Н	L	L					
Н	Н	L	Н	Н	Н					
Н	Н	L	Н	Х	$Q_0$					
Х	Х	Н	Н	Х	Z					

HIGH voltage level LOW voltage level H L X Z

Don't care

High impedance "off" state

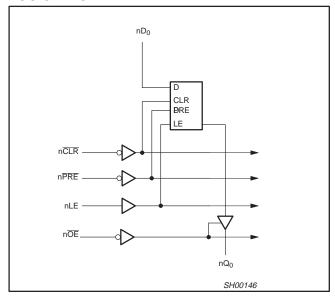
### **LOGIC SYMBOL**



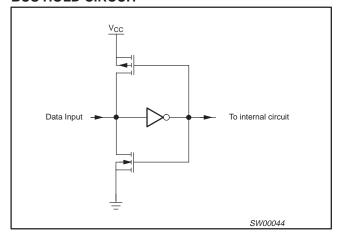
### 18-bit bus interface D-type latch (3-State)

### 74ALVCH16843

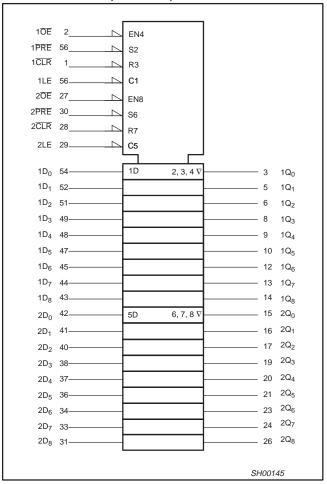
### **LOGIC DIAGRAM**



### **BUS HOLD CIRCUIT**



### LOGIC SYMBOL (IEEE/IEC)



### 18-bit bus interface D-type latch (3-State)

### 74ALVCH16843

### **RECOMMENDED OPERATING CONDITIONS**

SYMBOL	PARAMETER	CONDITIONS	MIN	MAX	UNIT
Vas	DC supply voltage 2.5V range (for max. speed performance @ 30 pF output load)		2.3	2.7	V
Vcc	DC supply voltage 3.3V range (for max. speed performance @ 50 pF output load)		3.0	3.6	V
V <sub>I</sub>	DC Input voltage range		0	V <sub>CC</sub>	V
V <sub>O</sub>	DC output voltage range		0	V <sub>CC</sub>	V
T <sub>amb</sub>	Operating free-air temperature range		-40	+85	°C
t <sub>r</sub> , t <sub>f</sub>	Input rise and fall times	$V_{CC} = 2.3 \text{ to } 3.0 \text{V}$ $V_{CC} = 3.0 \text{ to } 3.6 \text{V}$	0	20 10	ns/V

#### ABSOLUTE MAXIMUM RATINGS

In accordance with the Absolute Maximum Rating System (IEC 134) Voltages are referenced to GND (ground = 0V)

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V <sub>CC</sub>	DC supply voltage		-0.5 to +4.6	V
I <sub>IK</sub>	DC input diode current	V <sub>1</sub> < 0	<b>–</b> 50	mA
V	DC input voltage	For control pins <sup>2</sup>	-0.5 to +4.6	V
V <sub>I</sub>	DC Input voitage	For data inputs <sup>2</sup>	–0.5 to V <sub>CC</sub> +0.5	1 °
I <sub>OK</sub>	DC output diode current	$V_O > V_{CC}$ or $V_O < 0$	±50	mA
Vo	DC output voltage	Note 2	–0.5 to V <sub>CC</sub> +0.5	V
Io	DC output source or sink current	$V_{O} = 0$ to $V_{CC}$	±50	mA
I <sub>GND</sub> , I <sub>CC</sub>	DC V <sub>CC</sub> or GND current		±100	mA
T <sub>stg</sub>	Storage temperature range		-65 to +150	°C
P <sub>TOT</sub>	Power dissipation per package –plastic medium-shrink (SSOP) –plastic thin-medium-shrink (TSSOP)	For temperature range: –40 to +125 °C above +55°C derate linearly with 11.3 mW/K above +55°C derate linearly with 8 mW/K	850 600	mW

#### NOTE

<sup>1.</sup> Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

<sup>2.</sup> The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

# 18-bit bus interface D-type latch (3-State)

### 74ALVCH16843

### DC ELECTRICAL CHARACTERISTICS

Over recommended operating conditions. Voltage are referenced to GND (ground = 0 V).

				LIMITS		
SYMBOL	PARAMETER	TEST CONDITIONS	Temp :	= -40°C to +8	5°C	UNIT
		MIN	TYP <sup>1</sup>	MAX	1	
	LHOLLI Ll L L	V <sub>CC</sub> = 2.3 to 2.7V	1.7	1.2		.,
$V_{IH}$	HIGH level Input voltage	V <sub>CC</sub> = 2.7 to 3.6V	2.0	1.5		\ \
	LOW Is and I want to the ma	V <sub>CC</sub> = 2.3 to 2.7V		1.2	0.7	V
$V_{IL}$	LOW level Input voltage	V <sub>CC</sub> = 2.7 to 3.6V		1.5	0.8	1 °
		$V_{CC}$ = 2.3 to 3.6V; $V_I$ = $V_{IH}$ or $V_{IL}$ ; $I_O$ = $-100\mu A$	V <sub>CC</sub> -0.2	V <sub>CC</sub>		
		$V_{CC} = 2.3V$ ; $V_I = V_{IH}$ or $V_{IL}$ ; $I_O = -6$ mA	V <sub>CC</sub> -0.3	V <sub>CC</sub> -0.08		1
M	LUCI Llevel systems veltere	$V_{CC} = 2.3V$ ; $V_I = V_{IH}$ or $V_{IL}$ ; $I_O = -12mA$	V <sub>CC</sub> -0.6	V <sub>CC</sub> - 0.26		
$V_{OH}$	HIGH level output voltage	$V_{CC} = 2.7V$ ; $V_I = V_{IH}$ or $V_{IL}$ ; $I_O = -12mA$	V <sub>CC</sub> -0.5	V <sub>CC</sub> -0.14		1 °
		$V_{CC} = 3.0V$ ; $V_I = V_{IH}$ or $V_{IL}$ ; $I_O = -12mA$	V <sub>CC</sub> -0.6 V <sub>CC</sub> -0.			
		$V_{CC} = 3.0V$ ; $V_I = V_{IH}$ or $V_{IL}$ ; $I_O = -24$ mA	V <sub>CC</sub> -1.0	V <sub>CC</sub> - 0.28		1
		$V_{CC}$ = 2.3 to 3.6V; $V_I$ = $V_{IH}$ or $V_{IL}$ ; $I_O$ = 100 $\mu$ A		GND	0.20	٧
			0.07	0.40	V	
$V_{OL}$	LOW level output voltage	$V_{CC} = 2.3V$ ; $V_I = V_{IH}$ or $V_{IL}$ ; $I_O = 12mA$		0.15	0.70	
		$V_{CC} = 2.7V$ ; $V_I = V_{IH}$ or $V_{IL}$ ; $I_O = 12mA$		0.14	0.40	٧
		$V_{CC} = 3.0V$ ; $V_I = V_{IH}$ or $V_{IL}$ ; $I_O = 24mA$		0.27	0.55	1
IĮ	Input leakage current	$V_{CC} = 2.3 \text{ to } 3.6V;$ $V_{I} = V_{CC} \text{ or GND}$		0.1	5	μА
I <sub>OZ</sub>	3-State output OFF-state current	$V_{CC}$ = 2.3 to 3.6V; $V_I$ = $V_{IH}$ or $V_{IL}$ ; $V_O$ = $V_{CC}$ or GND		0.1	10	μА
I <sub>CC</sub>	Quiescent supply current	$V_{CC} = 2.3$ to 3.6V; $V_I = V_{CC}$ or GND; $I_O = 0$		0.2	40	μΑ
Δl <sub>CC</sub>	Additional quiescent supply current	$V_{CC} = 2.3V \text{ to } 3.6V; V_I = V_{CC} - 0.6V; I_O = 0$		150	750	μΑ
I <sub>BHL</sub> <sup>2</sup>	Bus hold LOW sustaining current	$V_{CC} = 2.3V; V_I = 0.7V$	45	-		μА
IBHL	Bus floid LOVV sustaining current	$V_{CC} = 3.0V; V_I = 0.8V$	75	150		μΛ
I <sub>BHH</sub> <sup>2</sup>	Bus hold HIGH sustaining current	V <sub>CC</sub> = 2.3V; V <sub>I</sub> = 1.7V	-45 -75	475		μΑ
	Due hold I OW overding a summer	$V_{CC} = 3.0V; V_{I} = 2.0V$	-75 500	<del>-</del> 175		^
I <sub>BHLO</sub> <sup>2</sup>	Bus hold LOW overdrive current	$V_{CC} = 3.6V$	500			μΑ
I <sub>BHHO</sub> <sup>2</sup>	Bus hold HIGH overdrive current	V <sub>CC</sub> = 3.6V	-500			μΑ

All typical values are at T<sub>amb</sub> = 25°C.
 Valid for data inputs of bus hold parts.

# 18-bit bus interface D-type latch (3-State)

74ALVCH16843

### AC CHARACTERISTICS FOR $V_{CC} = 2.3V$ TO 2.7V RANGE

 $GND = 0V; \ t_r = t_f \leq 2.0 ns; \ C_L = 30 pF$ 

				LIMITS		
SYMBOL	PARAMETER	WAVEFORM	V	<sub>CC</sub> = 2.3 to 2.	7V	UNIT
			MIN	TYP <sup>1</sup>	MAX	1
	Propagation delay nDn to nQn	1, 6	1.0	2.2	4.3	
. / <u>.</u>	Propagation delay nLE to nQn	2, 6	1.0	2.3	4.6	]
t <sub>PHL</sub> /t <sub>PLH</sub>	Propagation delay nPRE to nQn	1, 6	1.0	2.5	4.8	ns
	Propagation delay nCLR to nQn	1, 6	1.0	2.5	4.8	]
t <sub>PZH</sub> /t <sub>PZL</sub>	3-State output enable time nOE to nQn	5, 6	1.0	2.8	5.8	ns
t <sub>PHZ</sub> /t <sub>PLZ</sub>	3-State output disable time nOE to nQn	5, 6	1.1	2.2	4.3	ns
t <sub>SU</sub>	Set-up time nDn to nLE	3, 6	0.5	-0.1	-	ns
t <sub>h</sub>	Hold time nDn to nLE	3, 6	0.9	0.5	-	ns
	nLE pulse width HIGH	2, 6	1.5	0.5	-	
$t_{VV}$	nPRE pulse width LOW	4, 6	1.5	0.5	-	ns
	nCLR pulse width LOW	4, 6	1.5	0.5	-	1
	Recovery time nPRE to nLE	4, 6	0.5	1.1	-	
tREM	Recovery time nCLR to nLE	4, 6	0.5	1.0	-	ns

#### NOTE:

### AC CHARACTERISTICS FOR $V_{CC}$ = 3.0V TO 3.6V RANGE AND $V_{CC}$ = 2.7V

 $GND = 0V; \ t_r = t_f \leq 2.5 ns; \ C_L = 50 pF$ 

				LIMITS			LIMITS			
SYMBOL	PARAMETER	WAVEFORM	Vc	<sub>C</sub> = 3.3 ± 0	.3V	,	V <sub>CC</sub> = 2.7\	/	UNIT	
			MIN	TYP <sup>1, 2</sup>	MAX	MIN	TYP <sup>1</sup>	MAX	1	
	Propagation delay nDn to nQn	1, 6	1.0	2.1	3.5	1.0	2.3	4.0		
t/t	Propagation delay nLE to nQn	2, 6	1.0	2.0	3.5	1.0	2.1	3.9	ns	
t <sub>PHL</sub> /t <sub>PLH</sub>	Propagation delay nPRE to nQn	1, 6	1.0	2.2	3.8	1.0	2.6	4.5	115	
	Propagation delay nCLR to nQn	1, 6	1.0	2.3	3.9	1.0	2.5	4.3		
t <sub>PZH</sub> /t <sub>PZL</sub>	3-State output enable time nOE to nQn	5, 6	1.0	2.5	4.4	1.0	3.0	5.3	ns	
t <sub>PHZ</sub> /t <sub>PLZ</sub>	3-State output disable time nOE to nQn	5, 6	1.3	2.6	4.0	1.3	2.8	4.4	ns	
t <sub>SU</sub>	Set-up time nDn to nLE	3, 6	0.5	0.0	_	0.5	-0.3	_	ns	
t <sub>h</sub>	Hold time nDn to nLE	3, 6	0.9	0.5	-	0.9	0.5	_	ns	
	nLE pulse width HIGH	2, 6	1.5	0.5	-	1.5	0.5	-		
t <sub>W</sub>	nPRE pulse width LOW	4, 6	1.5	0.5	-	1.5	0.6	-	ns	
	nCLR pulse width LOW	4, 6	1.5	0.5	_	1.5	0.5	-	1	
t	Recovery time nPRE to nLE	4, 6	1.0	0.4	-	0.8	-0.2	-	ns	
t <sub>REM</sub>	Recovery time nCLR to nLE	4, 6	0.8	0.2	-	0.6	-0.4	-	115	

#### NOTES:

<sup>1.</sup> All typical values are at  $V_{CC}$  = 3.3V and  $T_{amb}$  = 25°C.

<sup>1.</sup> All typical values are measured  $T_{amb}$  = 25°C.

<sup>2.</sup> Typical value is measured at  $V_{CC} = 3.3V$ 

### 18-bit bus interface D-type latch (3-State)

### 74ALVCH16843

# AC WAVEFORMS FOR $V_{CC}$ = 2.3V TO 2.7V AND $V_{CC}$ < 2.3V RANGE

 $V_{M} = 0.5 \text{ V}$   $V_{X} = V_{OL} + 0.15 \text{V}$  $V_{Y} = V_{OH} - 0.15 \text{V}$ 

 $V_{\mbox{\scriptsize OL}}$  and  $V_{\mbox{\scriptsize OH}}$  are the typical output voltage drop that occur with the output load.

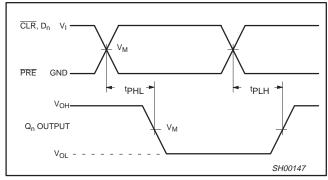
 $V_I = V_{C0}$ 

# AC WAVEFORMS FOR $V_{CC} = 3.0V$ TO 3.6V AND $V_{CC} = 2.7V$ RANGE

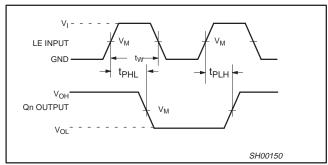
 $V_{M} = 1.5 V$   $V_{X} = V_{OL} + 0.3 V$  $V_{Y} = V_{OH} - 0.3 V$ 

 $V_{\mbox{\scriptsize OL}}$  and  $V_{\mbox{\scriptsize OH}}$  are the typical output voltage drop that occur with the output load.

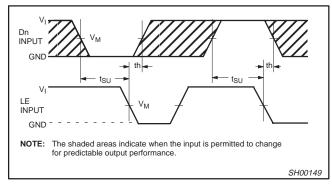
 $V_1 = 2.7V$ 



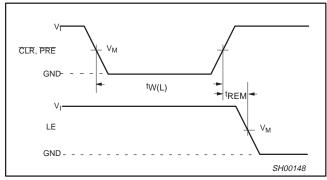
Waveform 1. Data input (Dn) to output (Qn), clear input (CLR) to output (Qn) and preset input (PRE) to output (Qn) propagation delay



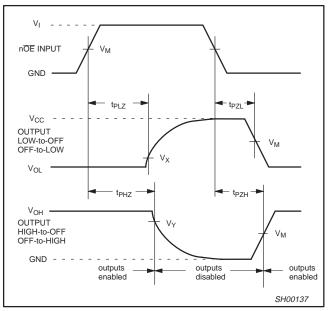
Waveform 2. Latch enable input (LE) pulse width, the latch enable input to output (Qn) propagation delay



Waveform 3. Data set-up and hold times for the Dn input to the LE input



Waveform 4. Clear (CLR) and preset (PRE) pulse width, the clear (CLR) and preset (PRE) to latch (LE) removal time

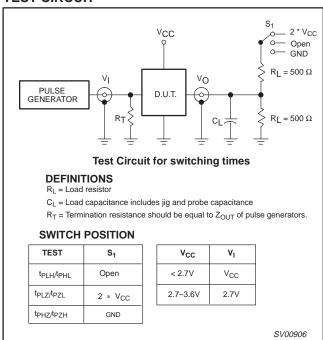


Waveform 5. 3-State enable and disable times

### 18-bit bus interface D-type latch (3-State)

### 74ALVCH16843

### **TEST CIRCUIT**



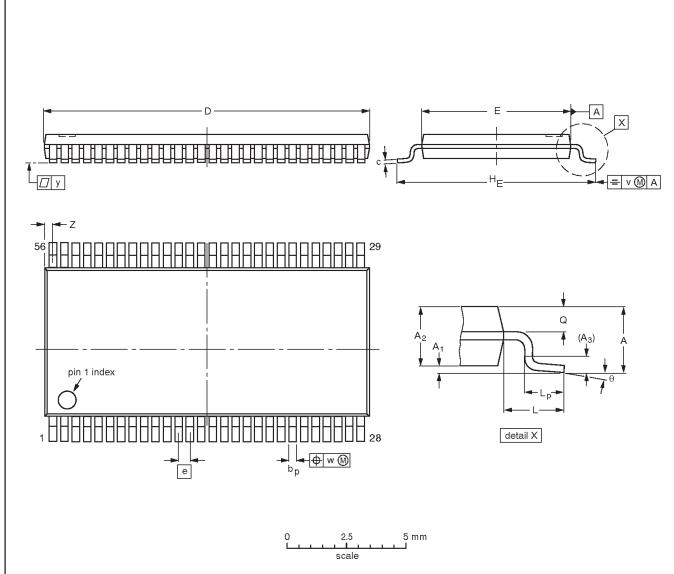
Waveform 6. Load circuitry for switching times

## 18-bit bus interface D-type latch (3-State)

### 74ALVCH16843

### TSSOP56: plastic thin shrink small outline package; 56 leads; body width 6.1mm

SOT364-1



### DIMENSIONS (mm are the original dimensions).

UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	bp	С	D <sup>(1)</sup>	E <sup>(2)</sup>	е	HE	L	Lp	Q	v	w	у	z	θ
mm	1.2	0.15 0.05	1.05 0.85	0.25	0.28 0.17	0.2 0.1	14.1 13.9	6.2 6.0	0.5	8.3 7.9	1.0	0.8 0.4	0.50 0.35	0.25	0.08	0.1	0.5 0.1	8° 0°

#### Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	RENCES		EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT364-1		MO-153EE				<del>-93-02-03</del> 95-02-10

18-bit bus interface D-type latch (3-State)

74ALVCH16843

**NOTES** 

### 18-bit bus interface D-type latch (3-State)

74ALVCH16843

#### Data sheet status

Data sheet status	Product status	Definition [1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
Preliminary specification	Qualification	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make chages at any time without notice in order to improve design and supply the best possible product.
Product specification	Production	This data sheet contains final specifications. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.

<sup>[1]</sup> Please consult the most recently issued datasheet before initiating or completing a design.

#### **Definitions**

**Short-form specification** — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

**Application information** — Applications that are described herein for any of these products are for illustrative purposes only. Philips Semiconductors make no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

#### **Disclaimers**

**Life support** — These products are not designed for use in life support appliances, devices or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips Semiconductors customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips Semiconductors for any damages resulting from such application.

Right to make changes — Philips Semiconductors reserves the right to make changes, without notice, in the products, including circuits, standard cells, and/or software, described or contained herein in order to improve design and/or performance. Philips Semiconductors assumes no responsibility or liability for the use of any of these products, conveys no license or title under any patent, copyright, or mask work right to these products, and makes no representations or warranties that these products are free from patent, copyright, or mask work right infringement, unless otherwise specified.

Philips Semiconductors 811 East Arques Avenue P.O. Box 3409 Sunnyvale, California 94088–3409 Telephone 800-234-7381 © Copyright Philips Electronics North America Corporation 1998 All rights reserved. Printed in U.S.A.

print code Date of release: 07-98

Document order number: 9397-750-04562

Let's make things better.

Philips Semiconductors



